



Automotive-grade N-channel 600 V, 0.26 Ω typ., 13 A MDmesh™ II Power MOSFET in a TO-247 package

Datasheet - production data

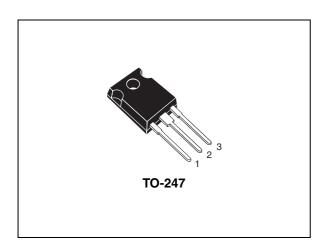
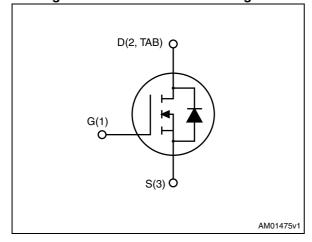


Figure 1. Internal schematic diagram



Features

Order code	V _{DS} (@T _{jmax})	R _{DS(on)} max.	I _D	P _{TOT}
STW19NM60N	650 V	$0.285~\Omega$	13 A	110 W

- Designed for automotive applications and AEC-Q101 qualified
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance

Applications

· Switching applications

Description

This device is an N-channel Power MOSFET developed using the second generation of MDmesh™ technology. This revolutionary Power MOSFET associates a vertical structure to the company's strip layout to yield one of the world's lowest on-resistance and gate charge. It is therefore suitable for the most demanding high efficiency converters.

Table 1. Device summary

Order codes	Marking	Package	Packaging
STW19NM60N	19NM60N	TO-247	Tube

Contents STW19NM60N

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STW19NM60N Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	600	V
V _{GS}	Gate- source voltage	± 25	
I _D	Drain current (continuous) at T _C = 25 °C	13	Α
I _D	Drain current (continuous) at T _C = 100 °C	8.2	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	52	Α
P _{TOT}	Total dissipation at T _C = 25 °C	110	W
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by T_J max)	4	А
E _{AS}	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AR}$, $V_{DD} = 50$ V)	350	mJ
dv/dt ⁽²⁾	Peak diode recovery voltage slope	15	V/ns
TJ	Operating junction temperature	55 to 150	
T _{stg}	Storage temperature	-55 to 150	°C

^{1.} Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1.14	°C/W
R _{thj-amb}	Thermal resistance junction-amb max	50	°C/W

^{2.} $I_{SD} \leq 13 \text{ A, di/dt } \leq 400 \text{ A/µs, } V_{DD} \leq 80 \text{ % } V_{(BR)DSS}, V_{DS(peak)} \leq V_{(BR)DSS}$

Electrical characteristics STW19NM60N

2 Electrical characteristics

(T_{CASE} =25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1 mA, V _{GS} = 0	600			٧
	Zero gate voltage drain	V _{DS} = 600 V			1	μΑ
DSS	current (V _{GS} = 0)	V _{DS} = 600 V, T _J =125 °C			10	μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ±25 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2	3	4	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D =6.5 A		0.260	0.285	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	1000	-	pF
C _{oss}	Output capacitance	$V_{DS} = 50 \text{ V, f} = 1 \text{ MHz,}$	-	60	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$	-	3	-	pF
C _{oss eq.} ⁽¹⁾	Output equivalent capacitance	$V_{DS} = 0$, to 480 V, $V_{GS} = 0$	-	225	-	pF
R_g	Intrinsic resistance	f=1 MHz open drain	-	3.5	-	Ω
Qg	Total gate charge	V _{DD} = 480 V, I _D = 13 A	-	35	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V (see Figure 15)	-	6	-	nC
Q _{gd}	Gate-drain charge		-	20	-	nC

^{1.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DS} .

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 300 \text{ V}, I_D = 6.5 \text{ A},$	-	12	-	ns
t _r	Rise time		-	15	-	ns
t _{d(off)}	Turn-off delay time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see Figure 14)	-	55	-	ns
t _f	Fall time		-	25	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		13	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		52	Α
V _{SD} ⁽²⁾	Forward on voltage $I_{SD} = 13 \text{ A}, V_{GS} = 0$		-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} =13 A, di/dt =100 A/μs, V _{DD} = 60 V	-	300		ns
Q _{rr}	Reverse recovery charge		-	4.0		μC
I _{RRM}	Reverse recovery current	(see Figure 16)	-	25		Α
t _{rr}	Reverse recovery time	V _{DD} = 60 V	-	360		ns
Q _{rr}	Reverse recovery charge	$di/dt = 100 \text{ A/}\mu\text{s}, I_{SD} = 13 \text{ A}$	-	4.5		μC
I _{RRM}	Reverse recovery current	Tj = 150°C (see Figure 16)	-	25		Α

^{1.} Pulse width limited by safe operating area

^{2.} Pulsed: pulse duration = $300 \mu s$, duty cycle 1.5%

Electrical characteristics STW19NM60N

10ms

VDS(V)

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Tc=25°C

100

Sinlge pulse

Figure 3. Thermal impedance

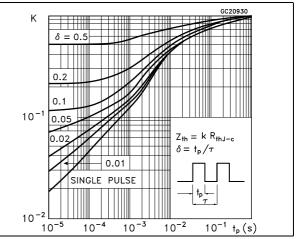
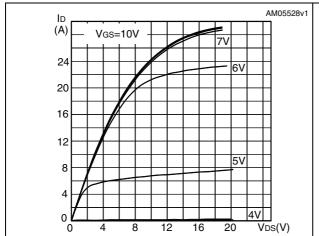


Figure 4. Output characteristics

Figure 5. Transfer characteristics



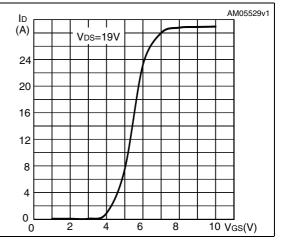
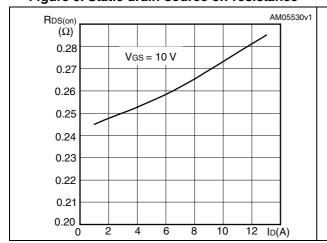
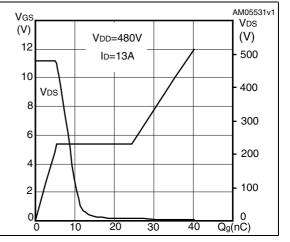


Figure 6. Static drain-source on-resistance

Figure 7. Gate charge vs gate-source voltage





0.1

Figure 8. Capacitance variations

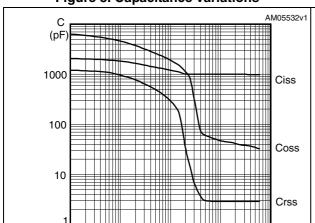


Figure 9. Output capacitance stored energy

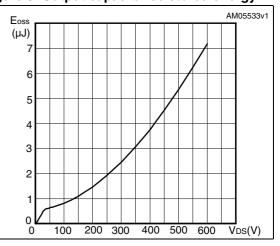


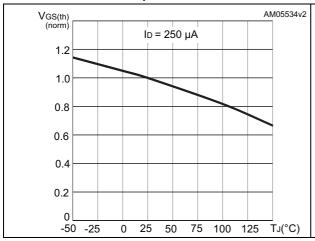
Figure 10. Normalized gate threshold voltage vs temperature

10

VDS(V)

100

Figure 11. Normalized on-resistance vs temperature



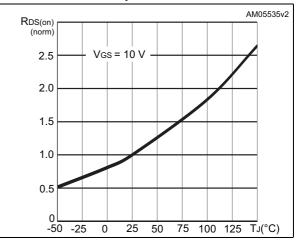
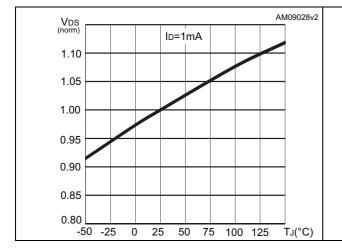
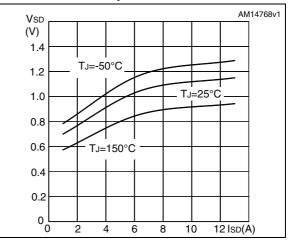


Figure 12. Normalized V_{DS} vs temperature

Figure 13. Source-drain diode forward vs temperature





Test circuits STW19NM60N

3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

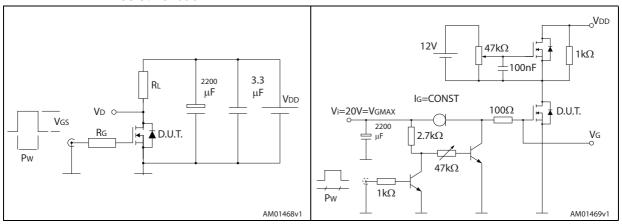


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

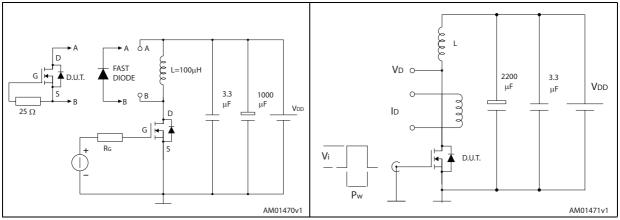
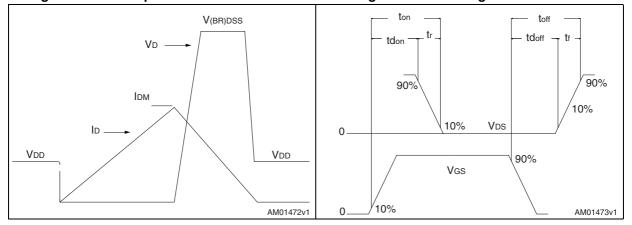


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



Table 8. TO-247 mechanical data

Dim		mm.	
Dim.	Min.	Тур.	Max.
Α	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
С	0.40		0.80
D	19.85		20.15
E	15.45		15.75
е	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

BACK VIEW 0075325, G

Figure 20. TO-247 drawing

Revision history STW19NM60N

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
21-Mar-2013	1	Initial release.
24-Oct-2013	2	- Modified: title, features and applications - Minor text changes

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